

VERSACLOCK® LOW POWER CLOCK GENERATOR

IDT5P49EE601

Description

The IDT5P49EE601 is a programmable clock generator intended for low power, battery operated consumer applications. There are four internal PLLs, each individually programmable, allowing for up to six differrent output frequencies. The frequencies are generated from a single reference clock. The reference clock can come from either a TCXO or fundamental mode crystal. An additional 32.768kHz crystal oscillator is available to provide a real time clock or non-critical performance MHz processor clock.

The IDT5P49EE601 can be programmed through the use of the I²C interfaces. The programming interface enables the device to be programmed when it is in normal operation or what is commonly known as in system programmable. An internal EEPROM allows the user to save and restore the configuration of the device without having to reprogram it on power-up.

Each of the four PLLs has an 8-bit reference divider and a 11-bit feedback divider. This allows the user to generate four unique non-integer-related frequencies. The PLL loop bandwidth is programmable to allow the user to tailor the PLL response to the application. For instance, the user can tune the PLL parameters to minimize jitter generation or to maximize jitter attenuation.

Spread spectrum generation is supported on one of the PLLs. The device is specifically designed to work with display applications to ensure that the spread profile remains consistent for each HSYNC in order to reduce ROW noise.

There are total five 8-bit output dividers. One output bank can be configured to support LVTTL or LVDS. All other outputs are always set to LVTTL. The outputs are connected to the PLLs via the switch matrix. The switch matrix allows the user to route the PLL outputs to any output bank. This feature can be used to simplify and optimize the board layout. In addition, each output's slew rate and enable/disable function can be programmed.

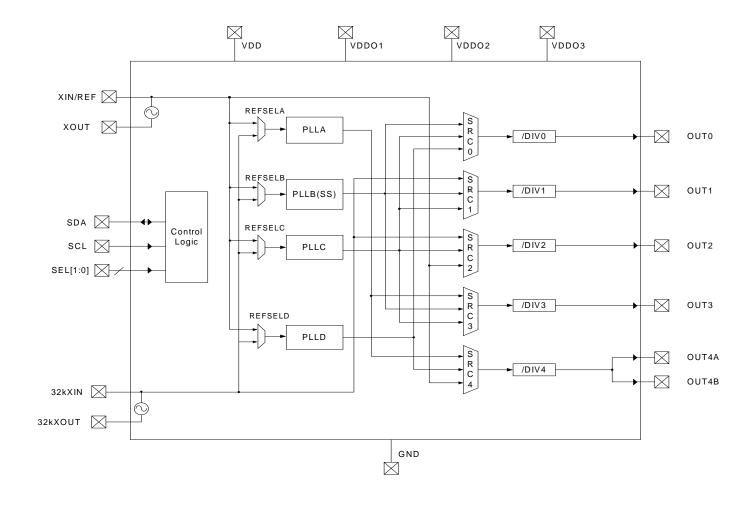
Target Applications

- Smart Mobile Handset
- Personal Navigation Device (PND)
- Camcorder
- DSC
- Portable Game Console
- Personal Media Player

Features

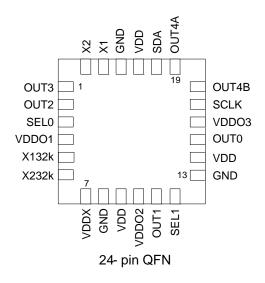
- Four internal PLLs
- Internal non-volatile EEPROM
 - Internal I²C EEPROM master interface
- FAST (400kHz) mode I²C serial interfaces
- Input Frequencies
 - TCXO: 10 MHz to 40 MHzCrystal: 8 MHz to 30 MHzRTC Crystal: 32.768 kHz
- Output Frequency Ranges: kHz to 120 MHz
- Each PLL has an 8-bit reference divider and a 11-bit feedback-divider
- 8-bit output-divider blocks
- One of the PLLs support Spread Spectrum generation capable of configuration to pixel rate, with adjustable modulation rate and amplitude to support video clock with no visible artifacts
- I/O Standards:
 - Outputs 1.8V/2.5V/3.3 V LVTTL/ LVCMOS
 - Outputs 1 pair selectable 3.3V LVDS
- 3 independent adjustable VDDO groups.
- Programmable Slew Rate Control
- Programmable Loop Bandwidth Settings
- Programmable output inversion to reduce bimodal jitter
- Individual output enable/disable
- Power-down/Sleep mode
 - 10µA max in power down mode
 - 32kHz clock output active sleep mode
 - 100µA max in sleep mode
- 1.8V VDD Core Voltage
- Available in 24pin 4x4mm QFN packages
- -40 to +85 C Industrial Temp operation

Functional Block Diagram



Note 1: OUT4A & OUT4B pair can be configured to be LVDS or two single-ended LVTTL outputs.

Pin Assignment



Pin Descriptions

Pin Name	Pin #	I/O	Pin Type	Pin Description
OUT3	1	0	Adjustable	Configurable clock output 3. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
OUT2	2	0	Adjustable	Configurable clock output 2. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
SEL0*	3	I	LVTTL	Configuration select pin. Weak internal pull down resistor.
VDDO1	4		Power	Device power supply. Connect to 3.3V. Using register settings, select output voltage levels for OUT0-OUT4. VDDO1 must be greater than or equal to both VDDO2 and VDDO3.
X132k	5	I	LVTTL	32kHz CRYSTAL_IN Reference crystal input
X232k	6	0	LVTTL	32kHz CRYSTAL_OUT Reference crystal feedback.
VDDx	7		Power	Crystal oscillator power supply. Connect to 1.8V. Use filtered analog power supply if available.
GND	8		Power	Connect to Ground.
VDD	9		Power	Device power supply. Connect to 1.8V.
VDDO2	10		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT3. VDDO2 must be equal or less than VDDO1.
OUT1	11	0	Adjustable	Configurable clock output 1. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
SEL1*	12	1	LVTTL	Configuration select pin. Weak internal pull down resistor.

GND	13		Power	Connect to Ground.	
VDD	14		Power	Device power supply. Connect to 1.8V.	
OUT0	15	0	Adjustable	Configurable clock output 0. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.	
VDD03	16		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT3. VDDO3 must be equal or less than VDDO1.	
SCLK	17	I	LVTTL	I ² C clock. Logic levels set by VDDO1. 5V tolerant.	
OUT4B	18	0	Adjustable	Configurable clock output 4B. Single-ended or differential who combined with OUT4A. Output voltage levels are controlled VDDO1.	
OUT4A	19	0	Adjustable	Configurable clock output 4A. Single-ended or differential when combined with OUT4B. Output voltage levels are controlled by VDDO1.	
SDA	20	I/O	Open Drain	Bidirectional I ² C data. Logic levels set by VDDO1. 5V tolerant.	
VDD	21		Power	Device power supply. Connect to 1.8V.	
GND	22		Power	Connect to Ground.	
XIN/ REF	23	I	LVTTL	MHz CRYSTAL_IN Reference crystal input or external reference clock input. Maximum reference clock input voltage is 1.8V.	
XOUT	24	0	LVTTL	MHz CRYSTAL_OUT Reference crystal feedback. Float pin if using reference input clock.	

Note *: SEL pins should be controlled by 1.8V LVTTL logic; 3.3V tolerant.

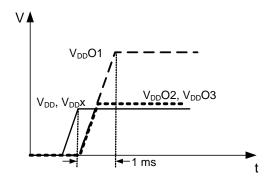
Note 1: Outputs are user programmable to drive single-ended 1.8V/2.5V/3.3V LVTTL. Differential LVDS interface levels can be generated for OUT4A/OUT4B when connected to VDDO1=3.3V and registers configured appropriately. Alway completely power up VDD and VDDx prior to applying VDDO power.

Note 2: Default configuration CLK1=Buffered MHz Reference output and CLK2=Buffered 32.768kHz output. All other outputs are off.

Note 3: Do not power up with SEL[1:0] = 00 (in Power down/Sleep mode).

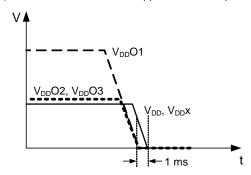
Ideal Power Up Sequence

- 1) V_{DD} and $V_{DD}x$ must come up first, followed by $V_{DD}O$
- 2) V_{DD}O1 must come up within 1ms after VDD and VDDX come up
- 3) V_{DD}O2/3 must be equal to, or lower than, V_{DD}O1
- 4) V_{DD} and V_{DD}x have approx. the same ramp rate
- 5) V_{DD}O1 and V_{DD}O2/3 have approx. same ramp rate

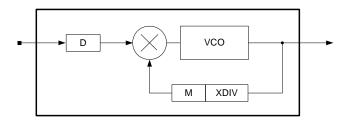


Ideal Power Down Sequence

- 1) $V_{DD}O$ must drop first, followed by V_{DD} and $V_{DD}x$
- 2) V_{DD} and $V_{DD}x$ must come down within 1ms after $V_{DD}O1$ comes down
- 3) V_{DD}O2/3 must be equal to, or lower than, V_{DD}O1
- 4) V_{DD} and V_{DD}x have approx. the same ramp rate
- 5) V_{DD}O1 and V_{DD}O2/3 have approx. same ramp rate



PLL Features and Descriptions



PLL Block Diagram

	Ref-Divider (D) Values	Feedback Pre-Divider (XDIV) Values	Feedback (M) Values	Programmable Loop Bandwidth	Spread Spectrum Generation Capability
PLLA	1 - 255	1 or 4	6 - 2047	Yes	No
PLLB	1 - 255	4	6 - 2047	Yes	Yes
PLLC	1 - 255	1 or 8 bit divide	6 - 2047	Yes	No
PLLD	1 - 255	1 or 4	6 - 2047	Yes	No

Crystal Input (XIN/REF)

The crystal oscillators should be fundamental mode quartz crystals; overtone crystals are not suitable. Crystal frequency should be specified for parallel resonance with 50Ω maximum equivalent series resonance. 0

ONXTALB=0 bit needs to be set for XIN/REF.

Crystal Load Capacitors

The device crystal connections should include pads for small capacitors from X1 to ground and from X2 to ground. These capacitors are used to adjust the stray capacitance of the board to match the nominally required crystal load capacitance. Because load capacitance can only be increased in this trimming process, it is important to keep stray capacitance to a minimum by using very short PCB traces (and no vias) between the crystal and device. Crystal capacitors must be connected from each of the pins X1 and X2 to ground.

The crystal cpacitors are internal to the device and have an effective value of 4pF.

Reference Pre-Divider, Reference Divider, Feedback-Divider and Post-Divider

Each PLL incorporates an 8-bit reference-scaler and a 11-bit feedback divider which allows the user to generate four unique non-integer-related frequencies. PLLA and PLLD each have a feedback pre-divider that provides additional multiplication for kHz reference clock applications. Each output divider supports 8-bit post-divider. The following equation governs how the output frequency is calculated.

$$F_{OUT} = \frac{F_{IN} * \left(\frac{XDIV*M}{D}\right)}{ODIV} (Eq. 2)$$

Where F_{IN} is the reference frequency, XDIV is the feedback pre-divider value, M is the feedback-divider value, D is the reference divider value, ODIV is the total post-divider value, and F_{OUT} is the resulting output frequency. Programming any of the dividers may cause glitches on the outputs.

SPREAD SPECTRUM GENERATION (PLLB)

PLLB has spread spectrum generation capability, which users have the option of turning on and off. Spread spectrum profile, frequency, and spread are fully programmable (within limits). The programmable spread spectrum generation parameters are NC[10:0], MOD[12:0], and NSS[10:0] bits. To enable spread spectrum, set SSENB B=0.

The spread spectrum circuitry was specifically developed to accommodate video display applications. The spread modulation frequency can be defined to exactly equal the horizontal line frequency (HSYNC)

NC[10:0]

These bits are used to determine the number of pulses per spread spectrum cycle. For video applications, NC is the number of pixels on the horizontal display row (or integer multiple of displayed pixels in a row). By matching the spread period to the screen, no tearing or "shimmer" will be apparent.

NC must be an even number to insure that the upward spread transition has the same number of steps as the downward spread transition.

For non-video applications, this can also be seen as the number of clock cycles for a complete spread spectrum period.

MOD[12:0]

These bits relate the VCO frequency to the target average spread output frequency (F_{MID}) .

$$F_{MID} = (F_{VCO}) / 8$$

$$F_{MAX} = F_{MID} + (SS\% * F_{MID})$$

$$F_{MIN} = F_{MID} - (SS\% * F_{MID})$$

$$MOD = (F_{REF}^* NC) / (2 * F_{MID})$$

NSS[10:0]

These bits control the amplitude of the spread modulation.

$$NSS = (NC / 2) + (NC / 8) * (F_{MAX} - F_{MIN}) / F_{MID}$$

Modulation frequency:

 $F_{MOD} = F_{MID} / NC$ (Eq. 11)

Video Example

 F_{REF} = 27 MHz, F_{OUT} = 27 MHz, 640 pixels per line, center spread of ±1%. Using F_{VCO} =432MHz, find the necessary spread spectrum register settings.

$$F_{MID} = F_{VCO}/8$$

NC = 640 (integer number of spread periods/screen)

$$MOD = (25MHz * 640)/(2 * 54MHz) = 160$$

NSS = (640/2)+(640/8)*(27.27MHz-26.73MHz)/27MHz = 321.

 $F_{MOD} = 27MHz/640 = 11.8kHz.$

Non-Video Example

 F_{REF} = 25MHz, F_{OUT} = 27 MHz, 31.25kHz modulation rate, center spread of ±1%. Find the necessary spread spectrum register settings.

$$F_{MID} = F_{VCO}/8$$

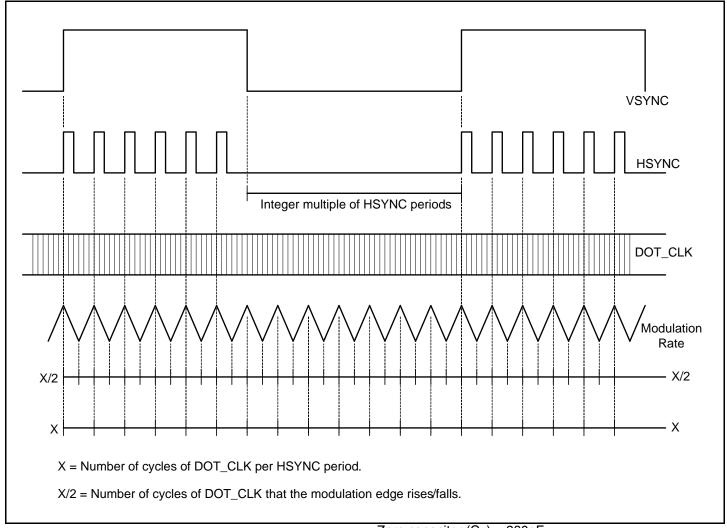
$$F_{MOD} = 31.25 \text{kHz} = 50.625 \text{MHz/NC}.$$

$$NC = 1620$$

$$MOD = (25MHz * 1620)/(2 * 50.625MHz) = 400$$

NSS = (1620/2)+(1620/8)*(27.27MHz-26.73MHz)/27MHz = 814.

VSYNC, HSYNC, DOT_CLK - Modulation Rate Relationship



LOOP FILTER

The loop filter for each PLL can be programmed to optimize the jitter performance. The low-pass frequency response of the PLL is the mechanism that dictates the jitter transfer characteristics. The loop bandwidth can be extracted from the jitter transfer. A narrow loop bandwidth is good for jitter attenuation while a wide loop bandwidth is best for low jitter generation. The specific loop filter components that can be programmed are the resistor via the RZ[4:0] bits, zero capacitor via the CZ[2:0] bits, pole capacitor via the CP[1:0] bits, and the charge pump current via the IP#[2:0] bits.

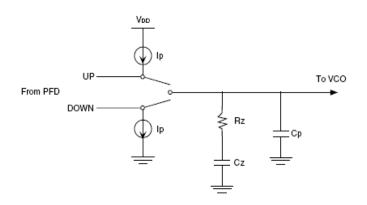
The following equations govern how the loop filter is set:

Zero capacitor (Cz) = 280pF

Pole capacitor (Cp) = 30pF

Charge pump (Ip) = IP#[2:0] uA

VCO gain (Kvco) = $300MHz/V * 2\pi$



PLL Loop Bandwidth:

Charge pump gain $(K\phi) = Ip / 2\pi$

VCO gain (Kvco) = 350MHz/V * 2π

M = Total multiplier value (See the PRE-SCALERS, FEEDBACK-DIVIDERS, POST-DIVIDERS section for more detail)

$$\omega c = (Rz * K \phi * K v co * Cz)/(M * (Cz + Cp))$$

 $Fc = \omega c / 2\pi$

Note, the phase/frequency detector frequency (FPFD) is typically seven times the PLL closed-loop bandwidth (Fc) but too high of a ratio will reduce your phase margin thus compromising loop stability.

To determine if the loop is stable, the phase margin (\$\phi m\$) would need to be calculated as follows.

Phase Margin:

$$\omega z = 1 / (Rz * Cz)$$

$$\omega p = (Cz + Cp)/(Rz * Cz * Cp)$$

$$\phi m = (360 / 2\pi) * [tan^{-1}(\omega c / \omega z) - tan^{-1}(\omega c / \omega p)]$$

To ensure stability in the loop, the phase margin is recommended to be $>60^{\circ}$ but too high will result in the lock time being excessively long. Certain loop filter parameters would need to be compromised to not only meet a required loop bandwidth but to also maintain loop stability.

Damping Factor:

 $\zeta = Rz/2 * (Kvco * Ip * Cz)^{1/2}/M$

Example

Fc = 150KHz is the desired loop bandwidth. The total A*M value is 160. The ζ (damping factor) target should be 0.7, meaning the loop is critically damped. Given Fc and A*M, an optimal loop filter setting needs to be solved for that will meet both the PLL loop bandwidth and maintain loop stability.

Choose a mid-range charge pump from register table

Icp= 11.9uA.

K_Φ * Kvco = 350MHz/V * 40uA = 12000A/Vs

 $\omega c = 2\pi * Fc = 9.42x10^{5} s^{-1}$

$$\omega p = (Cz + Cp)/(Rz * Cz * Cp) = \omega z (1 + Cz / Cp)$$

Solving for Rz, the best possible value Rz=30kOhms (RZ[1:0]=10) gives

 ζ = 1.4 (Ideal range for ζ is 0.7 to 1.4)

Solving back for the PLL loop bandwidth, Fc=149kHz.

The phase margin must be checked for loop stability.

$$\phi m = (360 \ / \ 2\pi) \ ^* \ [tan_{\text{-}1} \ (9.42x10^5 \ s^{\text{-}1} \ / \ 1.19x10^5 s^{\text{-}1}) \\ - \ tan_{\text{-}1} \ (9.42x10^5 \ s^{\text{-}1} \ / \ 1.23x10^6 \ s^{\text{-}1})] = 45^\circ$$

The phase margin would be acceptable with a fairly stable loop.

SEL[1:0] Function

The IDT5P49EE601 can support up to three unique configurations. Users may pre-program all configurations, selected using SEL[1:0] pins. Alternatively, users may use I2C interface to configure these registers on- the-fly.

Power Down/Sleep Mode is selected by the No_PD bit. No_PD=0 enables Power Down mode with no outputs. No PD=1 enables sleep mode with 32kHz output on OUT2.

Always power with SEL1=1 and/or SEL0=1.

SEL1	SEL0	Configuration Selections
0	0	Power Down/Sleep Mode
0	1	Select CONFIG0
1	0	Select CONFIG1
1	1	Select CONFIG2

Configuration OUTx IO Standard

Users can configure the individual output IO standard from a single 3.3V power supply. Each output can support 1.8V/

2.5V or 3.3V LVCMOS. Output pair OUT4A/OUT4B can be configured to support an LVDS output. For LVDS support, VDDO1 must be set to 3.3V. VDDO1 must have the highest voltage of any pin on the device. VDDO2 and VDDO3 may have any value between 1.8V and VDDO1.

The frame formats are shown in the following illustration.

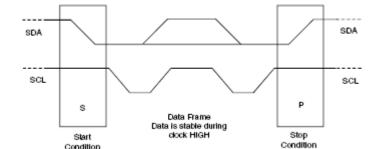
Programming the Device

I²C may be used to program the IDT5P49EE601.

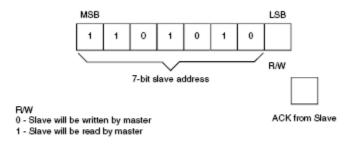
- Device (slave) address = 7'b1101010

I²C Programming

The IDT5P49EE601 is programmed through an I²C-Bus serial interface, and is an I²C slave device. The read and write transfer formats are supported. The first byte of data after a write frame to the correct slave address is interpreted as the register address; this address auto-increments after each byte written or read.



Framing



The first byte transmitted by the Master is the Slave Address followed by the R/W bit. The Slave acknowledges by sending a "1" bit.

First Byte Transmitted on I²C Bus

External I²C Interface Condition

KET	:
	From Master to Slave
	From Master to Slave, but can be omitted if followed by the correct sequence Normally data transfer is terminated by a STOP condition generated by the Master. However, if the Master still wishes to communicate on the bus, it can generate a repeated START condition, and address another Slave address without first generating a STOP condition.
	From Slave to Master

SYMBOLS:

ACK - Acknowledge (SDA LOW)
NACK - Not Acknowledge (SDA HIGH)
Sr - Repeated Start Condition

S - START Condition

P-STOP Condition

EEPROM Interface

The IDT5P49EE601 can store its configuration in an internal EEPROM. The contents of the device's internal programming registers can be saved to the EEPROM by issuing a save instruction (ProgSave) and can be loaded back to the internal programming registers by issuing a restore instruction (ProgRestore).

To initiate a save or restore using I²C, only two bytes are transferred. The Device Address is issued with the read/write bit set to "0", followed by the appropriate command code. The save or restore instruction executes

after the STOP condition is issued by the Master, during which time the IDT5P49EE601 will not generate Acknowledge bits. The IDT5P49EE601 will acknowledge the instructions after it has completed execution of them. During that time, the I²C bus should be interpreted as busy by all other users of the bus.

On power-up of the IDT5P49EE601, an automatic restore is performed to load the EEPROM contents into the internal programming registers. The IDT5P49EE601 will be ready to accept a programming instruction once it acknowledges its 7-bit I²C address.

Progwrite

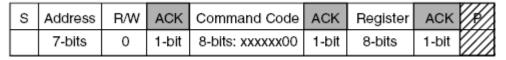
S	Address	R/W	ACK	Command Code	ACK	Register	ACK	Data	ACK	Р
	7-bits	0	1-bit	8-bits: xxxxxxx00	1-bit	8-bits	1-bit	8-bits	1-bit	

Progwrite Command Frame

Writes can continue as long as a Stop condition is not sent and each byte will increment the register address.

Progread

Note: If the expected read command is not from the next higher register to the previous read or write command, then set a known "read" register address prior to a read operation by issuing the following command:



Prior to Progread Command Set Register Address

The user can ignore the STOP condition above and use a repeated START condition instead, straight after the slave acknowledgement bit (i.e., followed by the Progread command):

S	Address	R/W	ACK	ID Byte	ACK	Data_1	ACK	Data_2	ACK	Data_last	NACK	Р
	7-bits	1	1-bit	8-bits	1-bit	8-bits	1-bit	8-bits	1-bit	8-bits	1-bit	

Progread Command Frame

Progsave

s	Address	RW	ACK	Command Code	ACK	Р
	7-bits	0	1-bit	8-bits:xxxxxx01	1-bit	

Note:

PROGWRITE is for writing to the IDT5P49EE601 registers. PROGREAD is for reading the IDT5P49EE601 registers. PROGSAVE is for saving all the contents of the IDT5P49EE601 registers to the EEPROM. PROGRESTORE is for loading the entire EEPROM contents to the IDT5P49EE601 registers.

Progrestore

s	Address	R/W	ACK	Command Code	ACK	Р
	7-bits	0	1-bit	8-bits:xxxxxx10	1-bit	

During PROGRESTORE, outputs will be turned off to ensure that no improper voltage levels are experienced before initialization.

I²C Bus DC Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IH}	Input HIGH Level		0.7xVDDO1		5.5	V
V _{IL}	Input LOW Level				0.3xVDDO1	V
V _{HYS}	Hysteresis of Inputs		0.05xVDDO1			V
I _{IN}	Input Leakage Current	$V_{DD} = 0V$			±1.0	μΑ
V _{OL}	Output LOW Voltage	I _{OL} = 3 mA			0.4	V

I²C Bus AC Characteristics for Standard Mode¹

Symbol	Parameter	Min	Тур	Max	Unit
F _{SCLK}	Serial Clock Frequency (SCL)	0		100	kHz
t _{BUF}	Bus free time between STOP and START	4.7			μs
t _{SU:START}	Setup Time, START	4.7			μs
t _{HD:START}	Hold Time, START	4			μs
t _{SU:DATA}	Setup Time, data input (SDA)	250			ns
t _{HD:DATA}	Hold Time, data input (SDA) ¹	0			μs
t _{OVD}	Output data valid from clock			3.45	μs
C _B	Capacitive Load for Each Bus Line			400	pF
t _R	Rise Time, data and clock (SDA, SCLK)			1000	ns
t _F	Fall Time, data and clock (SDA, SCLK)			300	ns
t _{HIGH}	HIGH Time, clock (SCLK)	4			μs
t _{LOW}	LOW Time, clock (SCLK)	4.7			μs
t _{SU:STOP}	Setup Time, STOP	4			μs

¹⁾ No activity is allowed on I²C lines until VDD>1.62V.

²⁾ A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V_{IH}MIN of the SCLK signal) to bridge the undefined region of the falling edge of SCLK.

I²C Bus AC Characteristics for Fast Mode¹

Symbol	Parameter	Min	Тур	Max	Unit
F _{SCLK}	Serial Clock Frequency (SCL)	0		400	kHz
t _{BUF}	Bus free time between STOP and START	1.3			μs
t _{SU:START}	Setup Time, START	0.6			μs
t _{HD:START}	Hold Time, START	0.6			μs
t _{SU:DATA}	Setup Time, data input (SDA)	100			ns
t _{HD:DATA}	Hold Time, data input (SDA) ¹	0			μs
t _{OVD}	Output data valid from clock			0.9	μs
C _B	Capacitive Load for Each Bus Line			400	pF
t _R	Rise Time, data and clock (SDA, SCL)	20 + 0.1xC _B		300	ns
t _F	Fall Time, data and clock (SDA, SCL)	20 + 0.1xC _B		300	ns
t _{HIGH}	HIGH Time, clock (SCL)	0.6			μs
t _{LOW}	LOW Time, clock (SCL)	1.3			μs
t _{SU:STOP}	Setup Time, STOP	0.6			μs

¹⁾ No activity is allowed on I²C lines until VDD>1.62V.

²⁾ A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the $V_{IH}MIN$ of the SCL signal) to bridge the undefined region of the falling edge of SCL.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the IDT5P49EE601. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Symbol	Description	Max	Unit
V _{DD}	Internal Power Supply Voltage	-0.5 to +4.6	V
VI	Input Voltage	-0.5 to +4.6	V
Vo	Output Voltage (not to exceed 4.6 V)	-0.5 to V _{DD} +0.5	V
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Recommended Operation Conditions

Symbol	Parameter	Min	Тур	Max	Unit
V _{DD} , V _{DD} x	Power supply voltage for VDD	1.71	1.8	1.89	V
V _{DD} O1	Power supply voltage for outputs including LVDS output pair OUT4A/OUT4B	3.135	3.3	3.465	
V _{DDOX}	Power supply voltage for outputs VDDO1/2/3	1.71	1.8	1.89	V
		2.375	2.5	2.625	V
		3.135	3.3	3.465	V
T _A	Operating temperature, ambient	-40		+85	°C
C _{LOAD_OUT}	Maximum load capacitance (3.3V LVTTL only)			15	pF
C _{LOAD_OUT}	Maximum load capacitance (1.8V or 2.5V LVTTL only)			8	pF
F _{IN}	External reference crystal	8		30	MHz
	External reference clock CLKIN	1		40	
XIN/REF	Voltage swing for clock input			VDD	V
t _{PU}	Power up time for all V _{DD} s to reach minimum specified voltage (power ramps must be monotonic)	0.05		5	ms

Capacitance $(T_A = +25 \text{ °C}, f = 1 \text{ MHz})$

Symbol	Parameter	Min	Тур	Max	Unit			
C _{IN}	Input Capacitance		3		pF			
Crystal Specifications								
XTAL_FREQ	Crystal frequency	8		30	MHz			
XTAL_MIN	Minimum crystal load capacitance		7		pF			
XTAL_MAX	Maximum crystal load capacitance		20		pF			

DC Electrical Characteristics for 3.3 Volt LVTTL ¹

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = 33mA	2.4		VDDO	V
V_{OL}	Output LOW Voltage	I _{OH} = 33mA			0.4	V
I _{OZDD}	Output Leakage Current	3-state outputs			5	μΑ

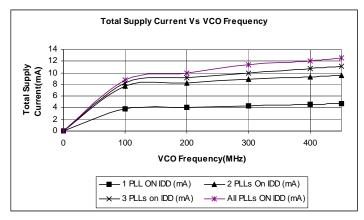
DC Electrical Characteristics for 2.5Volt LVTTL ¹

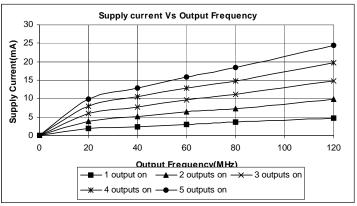
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = 25mA	2.1		VDDO	V
V_{OL}	Output LOW Voltage	I _{OH} = 25mA			0.4	V
I _{OZDD}	Output Leakage Current	3-state outputs			5	μΑ

DC Electrical Characteristics for 1.8Volt LVTTL ¹

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage	VDD = 1.71V to 1.89V	0.65*VDDO		VDDO	٧
V _{OL}	Output LOW Voltage				0.35*VDDO	V
V _{IH}	Input HIGH Voltage	SEL[1:0], 3.3V tolerant	0.75VDD			V
V _{IL}	Input LOW Voltage	SEL[1:0], 3.3V tolerant			0.25VDD	V
I _{OZDD}	Output Leakage Current	3-state outputs			5	μΑ

Power Supply Characteristics for LVTTL Outputs





1: See "Recommended Operating Conditions" table. Alway completely power up VDD and VDDx prior to applying VDDO power.

DC Electrical Characteristics for LVDS

Symbol	Parameter	Min	Тур	Max	Unit
V _{OT} (+)	Differential Output Voltage for the TRUE binary state	247		454	mV
V _{OT} (-)	Differential Output Voltage for the FALSE binary state	-247		-454	mV
\triangle V _{OT}	Change in V _{OT} between Complimentary Output States			50	mV
Vos	Output Common Mode Voltage (Offset Voltage)	1.125	1.2	1.375	V
△Vos	Change in V _{OS} between Complimentary Output States			50	mV
Ios	Outputs Short Circuit Current, V _{OUT} + or V _{OUT} = 0V or VDD		TBD	TBD	mA
I _{OSD}	Differential Outputs Short Circuit Current, V _{OUT} + = V _{OUT}		TBD	TBD	mA

Power Supply Characteristics for LVDS Outputs ¹

Symbol	Parameter	Parameter Test Conditions ²					
I _{DDQ}	Quiescent VDD Power Supply Current	REF = LOW Outputs enabled, all outputs unloaded	TBD	TBD	mA		
I _{DDD}	Dynamic VDD Power Supply Current per Output	$VDD = Max., C_L = 0pF$	TBD	TBD	μA/MHz		
I _{TOT}	Total Power VDD Supply Current	F _{REFERENCE CLOCK} = 25 MHz, C _L = 5 pF	TBD	TBD	mA		

¹⁾ OUT4A and OUT4B are toggling. Other outputs are powered down.

²⁾ The termination resistors are excluded from these measurements.

AC Timing Electrical Characteristics

(Spread Spectrum Generation = OFF)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
f _{IN}	Input Frequency	Input Frequency Limit (CLKIN)	1 ²		40	MHz	
1 / t1	Output Frequency	Single Ended Clock output limit (LVTTL) 3.3V	0.001		120	MHz	
		Single Ended Clock output limit (LVTTL) 2.5V			110	MHz	
		Single Ended Clock output limit (LVTTL) 1.8V			100	MHz	
		Differential Clock output limit (LVDS)			150	MHz	
f _{VCO}	VCO Frequency	VCO operating Frequency Range	100		500	MHz	
f _{PFD}	PFD Frequency	PFD operating Frequency Range	0.5 ²		20	MHz	
f _{BW}	Loop Bandwidth	Based on loop filter resistor and capacitor values				MHz	
t2	Input Duty Cycle	Duty Cycle for Input			60	%	
t3	Output Duty Cycle	Measured at VDD/2	45		55	%	
t4	Slew Rate, SLEWx(bits) = 00	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		5.1		V/ns	
	Slew Rate, SLEWx(bits) = 01	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		4.4			
	Slew Rate, SLEWx(bits) = 10	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		2.8			
	Slew Rate, SLEWx(bits) = 11	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		1.8			
t5	Rise Times	LVDS, 20% to 80%		600		ps	
	Fall Times			600			
t7	Clock Jitter	Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Single output frequency only.			100	ps	
		Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Multiple output frequencies switching.			200	ps	
t6	Output Skew	Skew between any output (Same freq and IO type, FOUT >10MHz)			200	ps	
t7	Lock Time	PLL Lock Time from Power-up (using MHz reference clock) ¹		5	20	ms	
		PLL Lock Time from Power-up using 32.768kHz reference clock)		1	3	S	
		PLL Lock time from shutdown mode		5	10	ms	

^{1.}Time from supply voltage crosses VDD=1.62V to PLLs are locked.

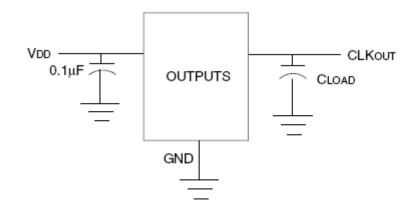
^{2.} Input clock (square wave) may be used at 1 MHz.

Spread Spectrum Generation Specifications

Symbol	Parameter	Description	Тур	Max	Unit	
f _{IN}	Input Frequency	Input Frequency Limit	1 ¹		40	MHz
f _{MOD}	Mod Frequency	Modulation Frequency 32 120				kHz
f _{SPREAD}	Spread Value	Amount of Spread Value (programmable) - Down Spread	Programmable			%f _{OUT}
		Amount of Spread Value (programmable) - Center Spread	Programmable			
		Total Spread Value	0.5		4.0	

Note 1: Practical lower frequency is determined by loop filter settings.

Test Circuits and Conditions ¹

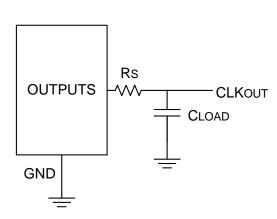


NOTE:

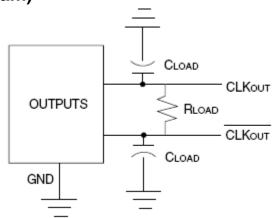
1. All Voo pins must be tied together.

Test Circuits for DC Outputs

Other Termination Scheme (Block Diagram)



LVTTL: ~7pF for each output



LVDS: 100Ω between differential outputs with 5pF

Programming Registers Table

	Default				В	it#				
Addr	Register Hex Value	7	6	5	4	3	2	1	0	Description
0x00	00	ONXTALB	CSX;	2[1:0]	CSX1	[1:0]	XTAL32ONB	Reserved		ONXTALB - MHz Crystal active low CSX2 [1:0]- internal 32kHz crystal cap2 00 - 18pF; 10 - 30pF 01 - 24pF; 11 - 36pF CSX1 [1:0] - Internal 32kHz crystal cap1 00 - 0pF; 10 - 6pF 01 - 3pF; 11 - 9pF XTAL32ONB - 32k crystal active low
0x01	00	INV[0]	SLEW	/0[0:1]	No_PD	Р	S0[2:1]	Re	eserved	No_PD - Enables/Disables 32kHz
0x02	00	I			Res	erved				clock output on Config 00.
0x03	00				Res	erved				No_PD=0 - 32kHz is off. No_PD=1 - 32kHz remains active.
0x04	00	INV[1]	SLEW	/1[0:1]	Reserved	Р	S1[2:1]	Re	eserved	INV[#] - Invert output#
0x05	00				Res	erved	-			SLEW#[0:1] - output# slew setting 0 0 - 5.1V/ns
0x06	00				Res	erved				0 1 - 4.4V/ns
0x07	00	INV[2]	SLEW	/2[0:1]	Reserved	F	PS22:1]	Re	eserved	1 0 - 2.8V/ns
0x08	00	INV[3]	SLEW	/3[0:1]	Reserved	Р	S3[2:1]	Re	eserved	1 1 - 1.8V/ns PS#[2:1] -Power Select
0x09	00	INV[4B]	INV[4A]	SLE	W4[0:1]		Rese	rved		00 - Reserved
										01 - CLK# connects to VDDO1 10 - CLK# connects to VDDO2 11 - CLK# connects to VDDO3s
0x0A	00				Res	erved				
0x0B	00				Res	erved				
0x0C	00				Res	erved				
0x0D	00				Res	erved				
0x0E	00					A[7:0]				Configuration0 REFA[7:0] - Reference Divide PLLA
0x0F	00				FBA	[10:3)				FBA[10:0] - Feedback Divide PLLA
0x10	00			Reserved				FBA[2:0)		
0x11	00	Reserved	XDIVA	RZ	A[1:0]		IPA[2:0]		REFSELA	XDIVA - FB predivide PLLA; 0 - /1; 1 - /4 RZA[1:0] - Zero Resistor PLLA 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IPA[2:0] - charge Pump Current PLLA 100 - 6.3uA 101 - 11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELA - Clock input PLLA 0 - MHz input 1 - 32kHz input
0x12	00				REF	B[7:0]			-1	REFB[7:0] - Reference Divide PLLB
0x13	00				FBB	[10:3]				FBB[10:0] - Feedback Divide PLLB
0x14	00	MOD[4:0] FBB[2:0]								PLLB Spread Parameters
0x15	00	MOD[12:5]								MOD[12:0] NC[10:0]
0x16	00	NC[10:3]								NSS[12:0]
0x17	00			NSS[4:0]				NC[2:0]		
0x18	00				NSS	[12:5]	L			

Name		Default				Е	Bit #				
Online	Addr		7	6	5	4	3	2	1	0	Description
Ox10		00		Reserved	Rese						-00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IIPB[2:0] - charge Pump Current PLLB 000 - 0.37uA, 100 - 6.3uA 001 - 1.1uA, 101 - 11.9uA 010 - 1.8 uA, 110 - 17.7uA 011 - 3.4uA, 111 - 22.7uA REFSELB - Clock input PLLB 0 - MHz input 1 - 32kHz input
Ox10											REFC[7:0] - Reference Divide PLLC
DATE 00 PEC2[7:0] PEC2[7:0] PEC2[7:0] Reserved XDIVC REFSELC REFSELC						FB	C[10:3]				FBC[10:0] - Feedback Divide PLLC
Turn on using XDIVC					Reserved	FD	2017 01		FBC[2:0]		EDOO E II L D II L DILO
No. PC(2:0)	UX1E	UU				FB(J∠[/:U]				
Description Page	0x1F	00	IPC[2:0] RZC[1:0] Reserved XDIVC REFSELC					00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IHC[2:0] - charge Pump Current PLLC 100 - 6.3uA 101 -11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELC 0 - MHz input			
No. No.	0x20	00				REI	FD[7:0]		l		REFD[7:0] - Reference Divide PLLD
Day						FBI	D[10:3]				FBD[10:0] - Feedback Divide PLLD
0 - /1; 1 - /4 RZD[1:0] - Zero Resistor PLLD 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm 11 - 17.7 uA 111 - 22.7 uA REFSELD[1:0] 00 - MHz input 11 - 32kHz input 00 - MHz input							IDDIO 01			E. D. ()	V2.0/2
0x25 00 Reserved 0x26 00 Reserved 0x27 00 OD1[7:0] 0x28 00 Reserved 0x29 00 Reserved 0x2A 00 OD2[7:0] 0x2B 00 OD3[7:0]			XDIVD	HZC	д1:0]				REFSELD[1:0]		0 - /1; 1 - /4 RZD[1:0] - Zero Resistor PLLD 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IPD[2:0] - charge Pump Current PLLD 100 - 6.3uA 101 -11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELD[1:0] 00 - MHz input 11 - 32kHz input Others - Reserved
0x26 00 Reserved 0x27 00 OD1[7:0] 0x28 00 Reserved 0x29 00 Reserved 0x2A 00 OD2[7:0] 0x2B 00 OD3[7:0]											OD#[7:0] - Output Divide#
0x27 00 OD1[7:0] 0x28 00 Reserved 0x29 00 Reserved 0x2A 00 OD2[7:0] 0x2B 00 OD3[7:0]											_
0x28 00 Reserved 0x29 00 Reserved 0x2A 00 OD2[7:0] 0x2B 00 OD3[7:0]											_
0x29 00 Reserved 0x2A 00 OD2[7:0] 0x2B 00 OD3[7:0]						_					
0x2A 00 OD2[7:0] 0x2B 00 OD3[7:0]											-
0x2B 00 OD3[7:0]											-
·											-
	0x2C	00				OE	04[7:0]				-

National Color		Default	Bit #									
Doc The content Doc Do	Addr	_	7	6	5	4	3	2	1	0	Description	
Do - off; 10 - PLLB Di - 324btz Reference; 11 - PLLD	0x2D	00	SCF	14[1:0]	SCR	3[1:0]	SCF	R2[1:0]	Re	served	00 - off; 10 - PLLC 01 - PLLA; 11 - MHz Reference SRC3[1:0] - OD3 source 00 - off; 10 - PLLA 01 - PLLC; 11 - PLLB SRC2[1:0] - OD2 source 00 - off; 10 - MHz Reference 01 - PLLC; 11 - 32kHz Reference	
DX30	0x2E	00	Res	erved	SCR	1[1:0]	Res	served	Reserved		00 - off; 10 - PLLB	
100 100	0x2F	01	SCF	R0[1:0]			R	eserved				
0x32 00 OE[3] OE[2] Reserved Reserved OE[1] Reserved Reserved OE[0] OE[0	0x30	FF			1	Re	served					
M32	0x31	00	PDB[4]	LVDS_ON	OE[4B]	OE[4A]		Re	served			
0.33	0x32	00	OE[3]	OE[2]	Reserved	Reserved	OE[1]	Reserved	Reserved	OE[0]		
Display			PDB[3]	PDB[2]	Reserved			Reserved	Reserved	PDB[0]	OE#=0, OUT# tri-stated. If PDB#=OE#=0, OUT# driven low LVDS_ON 0 - OUT4A/OUT4B - LVCMOS outputs 1 - OUT4A/OUT4B -LVDS outputs.	
NSS O												
0x37 00 Reserved XDIVA RZA[1:0] IPA[2:0] REFSELA 0x38 00 REFB[10:3] REFB[10:3] REFSELA 0x38 00 MOD[4:0] FBB[2:0] FBB[2:0] 0x3C 00 NS[4:0] NS[12:5] 0x3F 00 NSS[12:5] NSS[12:5] 0x3F 40 Reserved REFSELB SSENB_B 0x41 00 REFSC[10:3] FBC[10:3] 0x43 00 Reserved FBC[2:0] 0x44 00 FBC[2:0] REFSELD 0x45 00 IPC[2:0] REServed XDIV REFSELD 0x48 00 Reserved FBD[2:0] 0x4A 00 PREFSELD[1:0] REFSELD[1:0] 0x4B 00 REServed REFSELD[1:0]						FB	A[10:3)	1				
0x38 00 REFB[7:0] 0x39 00 FBB[10:3] 0x3B 00 MOD[4:0] FBB[2:0] 0x3B 00 MOD[12:5] 0x3C 00 NSS[4:0] NC[2:0] 0x3D 00 NSS[12:5] NC[2:0] 0x3F 40 Reserved IPB[2:0] RZB[1:0] 0x40 00 REFSELB SSENB_B 0x41 00 REFSC[7:0] 0x42 00 FBC[10:3] FBC[2:0] 0x44 00 IPC[2:0] REFSELC 0x44 00 IPC[2:0] REFSELD[1:0] 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 OD0[7:0] 0x4B 00 RESELD[1:0] 0x4B 00 REFSELD[1:0]			- /									
0x39 00 FBB[10:3] 0x3A 00 MOD[4:0] FBB[2:0] 0x3C 00 NC[10:3] NC[2:0] 0x3D 00 NSS[4:0] NC[2:0] 0x3E 00 NSS[12:5] NSS[12:5] 0x4D 00 Reserved REFSELB SSENB_B 0x41 00 REFC[7:0] SENB_B 0x42 00 FBC[10:3] FBC[2:0] 0x44 00 Reserved FBC[2:0] 0x44 00 IPC[2:0] RZC[1:0] Reserved 0x45 00 IPC[2:0] RZC[1:0] Reserved 0x47 00 FBD[10:3] FBD[10:3] 0x48 00 Reserved FBD[2:0] 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x40 00 Reserved Reserved REFSELD[1:0] REFSELD[1:0] 0x40 00 Reserved REFSELD[1:0] REFSELD[1:0] REFSELD[1:0]												
0x3A 00 MOD[4:0] FBB[2:0] 0x3B 00 MOD[12:5] MOD[12:5] 0x3C 00 NC[10:3] NC[2:0] 0x3B 00 NSS[4:0] NC[2:0] 0x3E 00 NSS[12:5] TC 0x4D 00 Reserved REFSELB SSENB_B 0x41 00 REFC[7:0] REFC[7:0] 0x43 00 Reserved FBC[2:0] 0x44 00 FBC[2:0] REFC[7:0] 0x44 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 REFD[7:0] FBD[10:3] FBD[2:0] REFSELC 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 RESERVED FBD[2:0] REFSELD[1:0] 0x4B 00 Reserved RESERVED 0x4C 00 Reserved RESERVED 0x4D RESERVED RESERVED												
0x3B 00 MOD[12:5] 0x3C 00 NC[10:3] 0x3D 00 NSS[4:0] NC[2:0] 0x3E 00 NSS[12:5] NSS[10:0] 0x40 00 Reserved REFSELB SSENB_B 0x41 00 REFC[7:0] REFSELB SSENB_B 0x42 00 FBC[10:3] FBC[2:0] FBC[2:0] 0x43 00 RESERVED FBC[2:0] REFSELD REFSELC 0x44 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 REFD[7:0] REFD[7:0] REFD[2:0] REFSELD[1:0] 0x47 00 RESERVED FBD[2:0] REFSELD[1:0] REFSELD[1:0] 0x48 00 RESERVED REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] 0x4B 00 RESERVED RESERVED RESERVED RESERVED 0x4C 00 RESERVED RESERVED RESERVED RESERVED 0x4E					MOD[4:0]	ГО	D[10.3]		EBB[3:0]		_	
0x3C 00 NS[4:0] NC[2:0] 0x3B 00 NSS[4:0] NSS[12:5] 0x3F 40 Reserved IPB[2:0] RZB[1:0] 0x40 00 REFC[7:0] REFSELB SSENB_B 0x41 00 REFC[7:0] FBC[10:3] 0x43 00 Reserved FBC[2:0] 0x44 00 FBC2[7:0] Reserved XDIV REFSELC 0x45 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 REFD[7:0] FBD[10:3] FBD[2:0] REFSELD[1:0] 0x48 00 RESERVED FBD[2:0] REFSELD[1:0] REFSELD[1:0] 0x4A 00 OD0[7:0] REFSELD[1:0] REFSELD[1:0] OD1[7:0] 0x4B 00 Reserved Reserved REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] OD1[7:0] 0x4B 00 Reserved REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] REFSELD[1:0					WOD[4.0]	MO	D[12·5]		1 00[2.0]		_	
0x3D 00 NSS[4:0] NC[2:0] 0x3E 00 Reserved IPB[2:0] RZB[1:0] 0x40 00 REFSELB SSENB_B 0x41 00 REFC[7:0] REFC[0:3] 0x42 00 FBC[10:3] FBC[2:0] 0x44 00 Reserved FBC2[7:0] 0x44 00 FBC2[7:0] REFSELC 0x44 00 IPC[2:0] REFD[1:0] REFSELC 0x45 00 IPC[2:0] REFD[1:0] REFSELC 0x46 00 FBD[10:3] FBD[2:0] FBD[2:0] 0x47 00 Reserved FBD[2:0] REFSELD[1:0] 0x48 00 REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] 0x4A 00 OD0[7:0] REFSELD[1:0] REFSELD[1:0] 0x4B 00 REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] 0x4B 00 REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] 0x4B 00 R											_	
0x3E 00 NSS[12:5] 0x3F 40 Reserved IPB[2:0] RZB[1:0] 0x40 00 REFSELB SSENB_B 0x41 00 REFC[7:0] FBC[10:3] 0x42 00 Reserved FBC[2:0] 0x43 00 Reserved FBC[2:0] 0x44 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x45 00 IPC[2:0] REFD[7:0] REFD[10:3] FBD[10:3] FBD[2:0] REFSELD[1:0] REFSELD[1:0] NX4B OX4B OX4D REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] OX4G OX4D OX4D REFSELD[1:0] REFSELD[1:0] OX4D OX4					NSS[4:0]		,[.0.0]		NC[2:0]			
0x40 00 Reserved REFSELB SSENB_B 0x41 00 REFC[7:0] FBC[10:3] FBC[10:3] 0x43 00 Reserved FBC[2:0] FBC[2:0] 0x44 00 FBC2[7:0] Reserved XDIV REFSELC 0x45 00 IPC[2:0] REFD[7:0] REFD[7:0] REFD[7:0] FBD[2:0] REFSELC 0x47 00 FBD[10:3] FBD[2:0] REFSELD[1:0] REFSELD[1:0] 0x48 00 REFSELD[1:0]						NS	S[12:5]		[]			
0x41 00 REFC[7:0] 0x42 00 FBC[10:3] 0x43 00 Reserved FBC[2:0] 0x44 00 FBC2[7:0] Reserved XDIV REFSELC 0x45 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 FBD[10:3] FBD[2:0] FBD[2:0] 0x48 00 Reserved FBD[2:0] REFSELD[1:0] 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 OD0[7:0] Reserved Reserved 0x4C 00 Reserved Reserved Reserved 0x4D 00 Reserved Reserved Reserved	0x3F	40		Reserved			IPB[2:0]		RZ	ZB[1:0]		
0x42 00 FBC[10:3] 0x43 00 Reserved FBC[2:0] 0x44 00 FBC2[7:0] Reserved XDIV REFSELC 0x45 00 IPC[2:0] REFD[7:0]	0x40	00			Rese	erved			REFSELB	SSENB_B		
0x43 00 Reserved FBC[2:0] 0x44 00 FBC2[7:0] RESERVED 0x45 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 REFD[7:0]	0x41	00				REI	FC[7:0]			1		
0x44 00 FBC2[7:0] 0x45 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 REFD[7:0]	0x42	00	FBC[10:3]									
0x45 00 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 00 REFD[7:0]	-				Reserved				FBC[2:0]			
0x46 00 REFD[7:0] 0x47 00 FBD[10:3] 0x48 00 Reserved FBD[2:0] 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 OD0[7:0] OD0[7:0] Reserved 0x4B 00 Reserved OD0[7:0] OD0[7:0] 0x4D 00 OD1[7:0] Reserved 0x4E 00 Reserved OD0[7:0]												
0x47 00 FBD[10:3] 0x48 00 Reserved FBD[2:0] 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 OD0[7:0] 0x4B 00 Reserved 0x4C 00 Reserved 0x4D 00 OD1[7:0] 0x4E 00 Reserved									REFSELC			
0x48 00 Reserved FBD[2:0] 0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 OD0[7:0] OD0[7:0] <td></td> <td></td> <td colspan="7"></td> <td></td>												
0x49 00 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 00 OD0[7:0] 0x4B 00 Reserved 0x4C 00 Reserved 0x4D 00 OD1[7:0] 0x4E 00 Reserved												
0x4A 00 OD0[7:0] 0x4B 00 Reserved 0x4C 00 Reserved 0x4D 00 OD1[7:0] 0x4E 00 Reserved									_			
0x4B 00 Reserved 0x4C 00 Reserved 0x4D 00 OD1[7:0] 0x4E 00 Reserved									4			
0x4C 00 Reserved 0x4D 00 OD1[7:0] 0x4E 00 Reserved									-			
0x4D 00 OD1[7:0] 0x4E 00 Reserved												
0x4E 00 Reserved												

	Default				Е	Bit #				
Addr	Register Hex Value	7	6	5	4	3	2	1	0	Description
0x50	00				OE	02[7:0]				
0x51	00				OD	03[7:0]				
0x52	00				10	D47:0]				
0x53	00	SCF	R4[1:0]	SCR	3[1:0]	SCR	21:0]	Res	served	
0x54	00	Res	erved	SCR	1[1:0]	Rese	erved	Res	served	
0x55	01	SCF	R0[1:0]			Re	served	I.		
0x56	FF				Re	served				
0x57	00	PDB[4]	LVDS_ON	OE[4B]	OE[4A]		Res	served		
0x58	00	OE[3]	OE[2]	Reserved	Reserved	OE[1]	Reserved	Reserved	OE[0]	
0x59	00	PDB[3]	PDB[2]	Reserved	Reserved	PDB[1]	Reserved	Reserved	PDB[0]	
0x5A	00		1	l .	RE	FA[7:0]	+	ļ	<u> </u>	Configuration2
0x5B	00				FB	A[10:3)				(See definitions from
0x5C	00			Reserved				FBA[2:0)		Configuration0 above)
0x5D	00	Reserved	XDIVA	RZA	[1:0]		IPA[2:0]	<u> </u>	REFSELA	
0x5E	00		1	l .		FB[7:0]	<u> </u>			
0x5F	00				FBI	B[10:3]				
0x60	00			MOD[4:0]				FBB[2:0]		
0x61	00				МО	D[12:5]	1			
0x62	00				NC	[10:3]				
0x63	00			NSS[4:0]				NC[2:0]		
0x64	00				NS	S[12:5]				_
0x65	40		Reserved			IPB[2:0]		RZ	B[1:0]	_
0x66	00			Rese	erved			REFSELB	SSENB_B	
0x67	00				REI	FC[7:0]			_	
0x68	00					C[10:3]				
0x69	00			Reserved				FBC[2:0]		_
0x6A	00				FB	C2[7:0]		-1 -1		
0x6B	00		IPC[2:0]			[1:0]	Reserved	XDIV	REFSELC	
0x6C	00		REFD[7:0]							
0x6D	00		FBD[10:3]							
0x6E	00			Reserved				FBD[2:0]		
0x6F	00	XDIVD	RZD	0[1:0]		IPD[2:0]			ELD[1:0]	_
0x70	00				OE	00[7:0]		1		_
0x71	00					served				_
0x72	00					served				_
0x73	00					01[7:0]				_
0x74	00					served				_
0x75	00		Reserved						_	
0x76	00					02[7:0]				-
0x77	00	OD3[7:0]						-		
0x78	00	OD4[7:0]						_		
0x79	00	SCR4[1:0] SCR3[1:0] SCR2[1:0] Reserved						served	-	
0x7A	00	Reserved SCR1[1:0] Reserved Reserved					-			
0x7B	01	SCR0[1:0] Reserved						-		
0x7C	FF	Reserved						-		
0x7D	00	PDB[4]							-	
0x7E	00	OE[3]	OE[2]	Reserved	Reserved	OE[1]	Reserved	Reserved	OE[0]	-
0x7F	00	PDB[3]	PDB[2]	Reserved	Reserved	PDB[1]	Reserved	Reserved	PDB[0]	-

Marking Diagram (NL24)



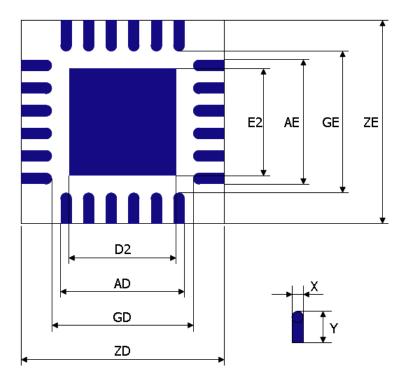
Notes:

- 1. "#" is the lot number.
- 2. YYWW is the last two digits of the year and week that the part was assembled.
- 3. "\$" is the assembly mark code.
- 4. "I" indicates industrial temperature range.

Thermal Characteristics for 24QFN

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	θ_{JA}	Still air		50.1		° C/W
Ambient	θ_{JA}	1 m/s air flow		43.1		° C/W
	θ_{JA}	2.5 m/s air flow		39.4		° C/W
Thermal Resistance Junction to Case	θ_{JC}			61.7		° C/W

Landing Pattern

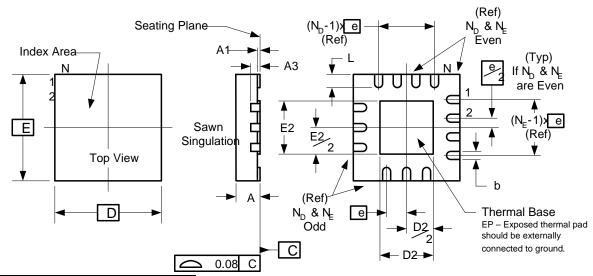


Dimensions			
X(max)	0.28		
Yref	0.69		
A(max)	2.78		
G(min)	2.93		
Z(max)	4.31		
E2/D2(max)	2.63		

Unit: mm

Package Outline and Package Dimensions (24-pin 4mm x 4mm QFN)

Package dimensions are kept current with JEDEC Publication No. 95



	Millin	neters			
Symbol	Min	Max			
Α	0.80	1.00			
A1	0	0.05			
A3	0.25 Re	eference			
b	0.18	0.30			
е	0.50 BASIC				
N	24				
N _D		6			
N _E	6				
D x E BASIC	4.00 x 4.00				
D2	2.3	2.55			
E2	2.3	2.55			
L	0.30	0.50			

Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
5P49EE601NLGI	See Page 23	Tubes	24pin VFQFPN	-40 to +85° C
5P49EE601NLGI8	See Page 23	Tape and Reel	24pin VFQFPN	-40 to +85° C

[&]quot;G" after the two-letter package code are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Device Technology (IDT) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

Revision History

Rev.	Date	Originator	Description of Change
	10/29/09	R.Willner	Preliminary Datasheet release.
Α	11/20/09	R.Willner	No_PD bit inclusion - 32kHz clock on/off in Config 00.
В	3/25/10	R.Willner	Typographical changes. Correct spread spectrum calculations.
С	6/11/10	R.Willner	Typographical changes. Default configuration.
D	9/08/10	R.Willner	Input Clock max voltage swing 1.8V. Power ramp sequence.
Е	10/29/10	R. Willner	Typographical changes. Loop filter calculations. Default register bit corrections.
F	01/19/11	R. Willner	Corrected notes for top-side marking.
G	04/13/11	R. Willner	 Updated SCLK and SDA pin descriptions Updated DC Electrical Char table for 1.8V LVTTL; added VIH and VIL. Updated "Lock Time/PLL Lock Time from shutdown mode" Typ. and Max. specs in AC Timing Electrical Char table.
Н	05/04/11	R. Willner	Added Landing Pattern diagram.
J	09/30/11	R. Willner	Updated Power-up/down sequence diagram notes.
K	10/17/11	R. Willner	Added VDDOx specs to Recommended Operations table Updated Power-up/down Sequence diagrams
L	07/25/12	R. Willner	Added pin 1 indicator dot on marking diagram.

Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

For Sales

800-345-7015 408-284-8200 Fax: 408-284-2775 For Tech Support

www.idt.com/go/clockhelp

Corporate Headquarters

Integrated Device Technology, Inc. www.idt.com

